74LVC2G240 Dual inverting buffer/line driver; 3-state Rev. 7 — 22 June 2012

**Product data sheet** 

### 1. General description

The 74LVC2G240 is a dual inverting buffer/line driver with 3-state outputs. The 3-state outputs are controlled by the output enable inputs 1OE and 2OE. A HIGH level at pins nOE causes the outputs to assume a high-impedance OFF-state. Schmitt trigger action at all inputs makes the circuit highly tolerant of slower input rise and fall times.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of the 74LVC2G240 as a translator in a mixed 3.3 V and 5 V environment.

It is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing a damaging backflow current through the device when it is powered down.

### 2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant input/output for interfacing with 5 V logic
- High noise immunity
- Complies with JEDEC standard:
  - ◆ JESD8-7 (1.65 V to 1.95 V)
  - ◆ JESD8-5 (2.3 V to 2.7 V)
  - JESD8-B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- ±24 mA output drive (V<sub>CC</sub> = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Multiple package options
- Specified from –40 °C to +85 °C and –40 °C to +125 °C



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### 3. Ordering information

| Table 1. Ordering | g information     |        |  |          |  |  |  |  |
|-------------------|-------------------|--------|--|----------|--|--|--|--|
| Type number       | Package           |        |  |          |  |  |  |  |
|                   | Temperature range | Name   | Description  | Version  |  |  |  |  |
| 74LVC2G240DP      | –40 °C to +125 °C | TSSOP8 | plastic thin shrink small outline package; 8 leads;<br>body width 3 mm; lead length 0.5 mm                       | SOT505-2 |  |  |  |  |
| 74LVC2G240DC      | –40 °C to +125 °C | VSSOP8 | plastic very thin shrink small outline package; 8 leads; body width 2.3 mm                                       | SOT765-1 |  |  |  |  |
| 74LVC2G240GT      | –40 °C to +125 °C | XSON8  | plastic extremely thin small outline package; no leads; 8 terminals; body 1 $\times$ 1.95 $\times$ 0.5 mm        | SOT833-1 |  |  |  |  |
| 74LVC2G240GF      | –40 °C to +125 °C | XSON8  | extremely thin small outline package; no leads; 8 terminals; body $1.35 \times 1 \times 0.5$ mm                  | SOT1089  |  |  |  |  |
| 74LVC2G240GD      | –40 °C to +125 °C | XSON8U | plastic extremely thin small outline package; no leads; 8 terminals; UTLP based; body $3 \times 2 \times 0.5$ mm | SOT996-2 |  |  |  |  |
| 74LVC2G240GM      | –40 °C to +125 °C | XQFN8  | plastic, extremely thin quad flat package; no leads; 8 terminals; body $1.6\times1.6\times0.5$ mm                | SOT902-2 |  |  |  |  |
| 74LVC2G240GN      | –40 °C to +125 °C | XSON8  | extremely thin small outline package; no leads; 8 terminals; body $1.2 \times 1.0 \times 0.35$ mm                | SOT1116  |  |  |  |  |
| 74LVC2G240GS      | –40 °C to +125 °C | XSON8  | extremely thin small outline package; no leads; 8 terminals; body $1.35 \times 1.0 \times 0.35$ mm               | SOT1203  |  |  |  |  |

### 4. Marking

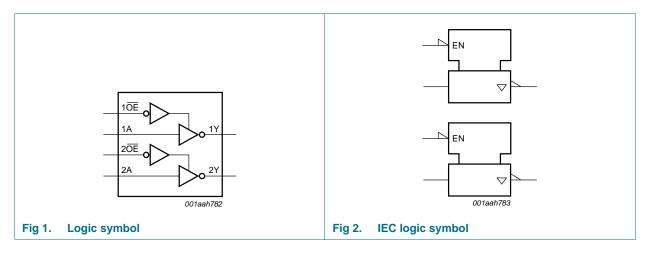
#### Table 2. Marking codes

| Type number  | Marking code <sup>[1]</sup> |
|--------------|-----------------------------|
| 74LVC2G240DP | V240                        |
| 74LVC2G240DC | V40                         |
| 74LVC2G240GT | V40                         |
| 74LVC2G240GF | V2                          |
| 74LVC2G240GD | V40                         |
| 74LVC2G240GM | V40                         |
| 74LVC2G240GN | V2                          |
| 74LVC2G240GS | V2                          |

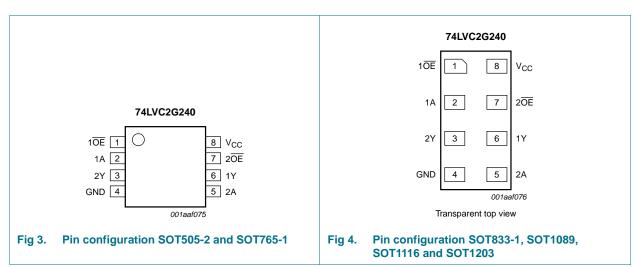
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

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### 5. Functional diagram

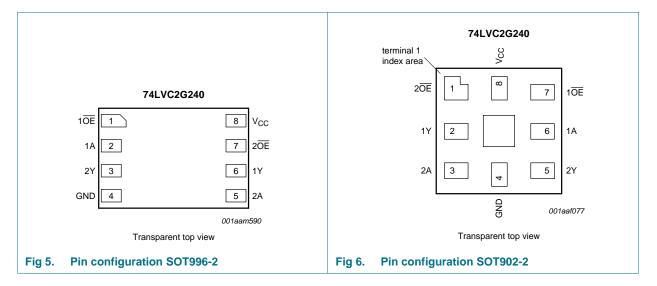


### 6. Pinning information



### 6.1 Pinning

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### 6.2 Pin description

| Table 3.          | Pin description   |             |   |
|-------------------|---|-------------|---|
| Symbol            | Pin   | Description |   |
|                   | SOT505-2, SOT765-1, SOT833-1, SOT1089,<br>SOT996-2, SOT1116 and SOT1203 | SOT902-2    |   |
| 1OE               | 1   | 7           | output enable input $1\overline{OE}$ (active LOW) |
| 1A                | 2   | 6           | data input  |
| 2Y                | 3   | 5           | data output                                       |
| GND               | 4   | 4           | ground (0 V)                                      |
| 2A                | 5   | 3           | data input  |
| 1Y                | 6   | 2           | data output                                       |
| 2 <mark>0E</mark> | 7   | 1           | output enable input $2\overline{OE}$ (active LOW) |
| V <sub>CC</sub>   | 8   | 8           | supply voltage                                    |
|                   |   |             |   |

### 7. Functional description

| Table 4.     | Function table <sup>[1]</sup> |    |        |
|--------------|-------------------------------|----|--------|
| Input<br>nOE |                               |    | Output |
| nOE          |                               | nA | nY     |
| L            |                               | L  | Н      |
| L            |                               | Н  | L      |
| Н            |                               | X  | Z      |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

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### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions                                      | Min                | Мах            | Unit |
|------------------|-------------------------|---|--------------------|----------------|------|
| V <sub>CC</sub>  | supply voltage          |   | -0.5               | +6.5           | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < 0 V                            | -50                | -              | mA   |
| VI               | input voltage           |   | <u>[1]</u> –0.5    | +6.5           | V    |
| I <sub>OK</sub>  | output clamping current | $V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V | -                  | ±50            | mA   |
| Vo               | output voltage          | Enable mode                                     | <u>[1]</u> –0.5    | $V_{CC} + 0.5$ | V    |
|                  |                         | Disable mode                                    | <u>[1]</u> –0.5    | +6.5           | V    |
|                  |                         | Power-down mode                                 | <u>[1][2]</u> –0.5 | +6.5           | V    |
| lo               | output current          | $V_{O} = 0 V$ to $V_{CC}$                       | -                  | ±50            | mA   |
| I <sub>CC</sub>  | supply current          |   | -                  | 100            | mA   |
| I <sub>GND</sub> | ground current          |   | -100               | -              | mA   |
| T <sub>stg</sub> | storage temperature     |   | -65                | +150           | °C   |
| P <sub>tot</sub> | total power dissipation | $T_{amb}$ = -40 °C to +125 °C                   | <u>[3]</u>         | 300            | mW   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When  $V_{CC} = 0$  V (Power-down mode), the output voltage can be 5.5 V in normal operation.

[3] For TSSOP8 packages: above 55 °C the value of P<sub>tot</sub> derates linearly at 2.5 mW/K.
 For VSSOP8 packages: above 110 °C the value of P<sub>tot</sub> derates linearly at 8.0 mW/K.
 For XSON8, XSON8U and XQFN8 packages: above 118 °C the value of P<sub>tot</sub> derates linearly with 7.8 mW/K.

### 9. Recommended operating conditions

#### Table 6. Operating conditions

|                               | e per un g e e maner e                            |  |                 |      |      |
|-------------------------------|---|--|-----------------|------|------|
| Symbol                        | Parameter   | Conditions   | Min             | Max  | Unit |
| V <sub>CC</sub>               | supply voltage                                    |  | 1.65            | 5.5  | V    |
| VI                            | input voltage                                     |  | 0               | 5.5  | V    |
| V <sub>O</sub> output voltage | V <sub>CC</sub> = 1.65 V to 5.5 V;<br>Enable mode | 0  | V <sub>CC</sub> | V    |      |
|                               |   | $V_{CC}$ = 1.65 V to 5.5 V;<br>Disable mode        | 0               | 5.5  | V    |
|                               |   | $V_{CC} = 0 V$ ; Power-down mode                   | 0               | 5.5  | V    |
| T <sub>amb</sub>              | ambient temperature                               |  | -40             | +125 | °C   |
| $\Delta t / \Delta V$         | input transition rise and fall rate               | $V_{CC}$ = 1.65 V to 2.7 V                         | -               | 20   | ns/V |
|                               |   | $V_{CC} = 2.7 \text{ V} \text{ to } 5.5 \text{ V}$ | -               | 10   | ns/V |
|                               |   |  |                 |      |      |

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### **10. Static characteristics**

#### Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol               | Parameter                 | Conditions   | Min                        | Typ <mark>[1]</mark> | Мах                  | Unit |
|----------------------|---------------------------|--|----------------------------|----------------------|----------------------|------|
| T <sub>amb</sub> = - | -40 °C to +85 °C          |  |                            |                      |                      |      |
| V <sub>IH</sub>      | HIGH-level input voltage  | $V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$   | $0.65 \times V_{CC}$       | -                    | -                    | V    |
|                      |                           | $V_{CC}$ = 2.3 V to 2.7 V  | 1.7                        | -                    | -                    | V    |
|                      |                           | $V_{CC} = 2.7 V \text{ to } 3.6 V$   | 2.0                        | -                    | -                    | V    |
|                      |                           | $V_{CC}$ = 4.5 V to 5.5 V  | $0.7 \times V_{\text{CC}}$ | -                    | -                    | V    |
| V <sub>IL</sub>      | LOW-level input voltage   | V <sub>CC</sub> = 1.65 V to 1.95 V   | -                          | -                    | $0.35 \times V_{CC}$ | V    |
|                      |                           | $V_{CC}$ = 2.3 V to 2.7 V  | -                          | -                    | 0.7                  | V    |
|                      |                           | $V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$   | -                          | -                    | 0.8                  | V    |
|                      |                           | $V_{CC}$ = 4.5 V to 5.5 V  | -                          | -                    | $0.3 \times V_{CC}$  | V    |
| V <sub>OL</sub>      | LOW-level output voltage  | $V_{I} = V_{IH} \text{ or } V_{IL}$  |                            |                      |                      |      |
|                      |                           | $I_{O}$ = 100 $\mu A;$ $V_{CC}$ = 1.65 V to 5.5 V  | -                          | -                    | 0.1                  | V    |
|                      |                           | $I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$  | -                          | -                    | 0.45                 | V    |
|                      |                           | $I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$   | -                          | -                    | 0.3                  | V    |
|                      |                           | $I_{O}$ = 12 mA; $V_{CC}$ = 2.7 V  | -                          | -                    | 0.4                  | V    |
|                      |                           | $I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$  | -                          | -                    | 0.55                 | V    |
|                      |                           | $I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$  | -                          | -                    | 0.55                 | V    |
| V <sub>OH</sub>      | HIGH-level output voltage | $V_{I} = V_{IH} \text{ or } V_{IL}$  |                            |                      |                      |      |
|                      |                           | $I_O$ = –100 $\mu A;$ $V_{CC}$ = 1.65 V to 5.5 V   | $V_{CC} - 0.1$             | -                    | -                    | V    |
|                      |                           | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$   | 1.2                        | -                    | -                    | V    |
|                      |                           | $I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$  | 1.9                        | -                    | -                    | V    |
|                      |                           | $I_{O}$ = -12 mA; $V_{CC}$ = 2.7 V   | 2.2                        | -                    | -                    | V    |
|                      |                           | $I_{O} = -24$ mA; $V_{CC} = 3.0$ V   | 2.3                        | -                    | -                    | V    |
|                      |                           | $I_{O}$ = -32 mA; $V_{CC}$ = 4.5 V   | 3.8                        | -                    | -                    | V    |
| l <sub>l</sub>       | input leakage current     | $V_{\rm I}$ = 5.5 V or GND; $V_{CC}$ = 0 V to 5.5 V  | -                          | ±0.1                 | ±5                   | μΑ   |
| l <sub>oz</sub>      | OFF-state output current  | $\label{eq:VI} \begin{array}{l} V_{I} = V_{IH} \text{ or } V_{IL}; \ V_{O} = 5.5 \ V \text{ or } GND; \\ V_{CC} = 3.6 \ V \end{array}$ | -                          | ±0.1                 | ±10                  | μΑ   |
| I <sub>OFF</sub>     | power-off leakage current | $V_{I} \text{ or } V_{O} = 5.5 \text{ V};  V_{CC} = 0 \text{ V}$   | -                          | ±0.1                 | ±10                  | μΑ   |
| I <sub>CC</sub>      | supply current            | $V_{I} = 5.5 \text{ V or GND}; I_{O} = 0 \text{ A};$<br>$V_{CC} = 1.65 \text{ V to 5.5 V}$   | -                          | 0.1                  | 10                   | μΑ   |
| $\Delta I_{CC}$      | additional supply current | per pin; V <sub>I</sub> = V <sub>CC</sub> – 0.6 V; I <sub>O</sub> = 0 A;<br>V <sub>CC</sub> = 2.3 V to 5.5 V                           | -                          | 5                    | 500                  | μΑ   |
| Cı                   | input capacitance         |  | -                          | 2                    | -                    | pF   |

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| Symbol                       | Parameter                 | Conditions  | Min                        | Typ <mark>[1]</mark> | Max                  | Unit |
|------------------------------|---------------------------|---|----------------------------|----------------------|----------------------|------|
| Г <sub>ать</sub> = –         | 40 °C to +125 °C          |   |                            |                      |                      |      |
| / <sub>IH</sub>              | HIGH-level input voltage  | V <sub>CC</sub> = 1.65 V to 1.95 V  | $0.65 \times V_{CC}$       | -                    | -                    | V    |
|                              |                           | $V_{CC}$ = 2.3 V to 2.7 V   | 1.7                        | -                    | -                    | V    |
|                              |                           | $V_{CC}$ = 2.7 V to 3.6 V   | 2.0                        | -                    | -                    | V    |
|                              |                           | $V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$  | $0.7 \times V_{\text{CC}}$ | -                    | -                    | V    |
| / <sub>IL</sub>              | LOW-level input voltage   | V <sub>CC</sub> = 1.65 V to 1.95 V  | -                          | -                    | $0.35 \times V_{CC}$ | V    |
|                              |                           | $V_{CC}$ = 2.3 V to 2.7 V   | -                          | -                    | 0.7                  | V    |
|                              |                           | $V_{CC}$ = 2.7 V to 3.6 V   | -                          | -                    | 0.8                  | V    |
|                              |                           | $V_{CC} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$  | -                          | -                    | $0.3 	imes V_{CC}$   | V    |
| VoL LOW-level output voltage | LOW-level output voltage  | $V_{I} = V_{IH} \text{ or } V_{IL}$   |                            |                      |                      |      |
|                              |                           | $I_0 = 100 \ \mu\text{A}; \ V_{CC} = 1.65 \ \text{V}$ to 5.5 V                                    | -                          | -                    | 0.1                  | V    |
|                              |                           | I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V   | -                          | -                    | 0.70                 | V    |
|                              |                           | $I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$  | -                          | -                    | 0.45                 | V    |
|                              |                           | $I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$   | -                          | -                    | 0.60                 | V    |
|                              |                           | $I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$   | -                          | -                    | 0.80                 | V    |
|                              |                           | $I_0 = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$   | -                          | -                    | 0.80                 | V    |
| / <sub>ОН</sub>              | HIGH-level output voltage | $V_{I} = V_{IH} \text{ or } V_{IL}$   |                            |                      |                      |      |
|                              |                           | $I_{O}$ = -100 $\mu$ A; $V_{CC}$ = 1.65 V to 5.5 V  | $V_{CC} - 0.1$             | -                    | -                    | V    |
|                              |                           | $I_0 = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$  | 0.95                       | -                    | -                    | V    |
|                              |                           | $I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$   | 1.7                        | -                    | -                    | V    |
|                              |                           | $I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$  | 1.9                        | -                    | -                    | V    |
|                              |                           | $I_0 = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$  | 2.0                        | -                    | -                    | V    |
|                              |                           | $I_0 = -32$ mA; $V_{CC} = 4.5$ V  | 3.4                        | -                    | -                    | V    |
| I                            | input leakage current     | $V_{I}$ = 5.5 V or GND; $V_{CC}$ = 0 V to 5.5 V   | -                          | -                    | ±20                  | μΑ   |
| OZ                           | OFF-state output current  |   | -                          | -                    | ±20                  | μΑ   |
| OFF                          | power-off leakage current | $V_{I}$ or $V_{O}$ = 5.5 V; $V_{CC}$ = 0 V  | -                          | -                    | ±20                  | μA   |
| сс                           | supply current            | $V_{I} = 5.5 \text{ V or GND}; I_{O} = 0 \text{ A};$<br>$V_{CC} = 1.65 \text{ V to 5.5 V}$        | -                          | -                    | 40                   | μΑ   |
| VI <sub>CC</sub>             | additional supply current | per pin; $V_I = V_{CC} - 0.6 \text{ V}$ ; $I_O = 0 \text{ A}$ ; $V_{CC} = 2.3 \text{ V}$ to 5.5 V | -                          | -                    | 5                    | mA   |

#### Table 7. Static characteristics ... continued

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[1] Typical values are measured at V<sub>CC</sub> = 3.3 V and T<sub>amb</sub> = 25 °C.

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#### Dual inverting buffer/line driver; 3-state

### **11. Dynamic characteristics**

#### Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

| Symbol           | Parameter         | Conditions                          |            | –40 °C to +85 °C |                      |      | –40 °C to +125 °C |      | Unit |
|------------------|-------------------|-------------------------------------|------------|------------------|----------------------|------|-------------------|------|------|
|                  |                   |                                     |            | Min              | Typ <mark>[1]</mark> | Max  | Min               | Max  |      |
| t <sub>pd</sub>  | propagation delay | nA to nY; see Figure 7              | [2]        |                  |                      |      |                   |      |      |
|                  |                   | $V_{CC}$ = 1.65 V to 1.95 V         |            | 1.0              | 4.1                  | 9.5  | 1.0               | 11.9 | ns   |
|                  |                   | $V_{CC}$ = 2.3 V to 2.7 V           |            | 0.5              | 2.6                  | 5.2  | 0.5               | 6.5  | ns   |
|                  |                   | $V_{CC} = 2.7 V$                    |            | 1.0              | 3.0                  | 5.5  | 1.0               | 6.9  | ns   |
|                  |                   | $V_{CC}$ = 3.0 V to 3.6 V           |            | 0.5              | 2.5                  | 4.6  | 0.5               | 5.8  | ns   |
|                  |                   | $V_{CC}$ = 4.5 V to 5.5 V           |            | 0.5              | 2.0                  | 4.0  | 0.5               | 5.0  | ns   |
| t <sub>en</sub>  | enable time       | nOE to nY; see Figure 8             | <u>[3]</u> |                  |                      |      |                   |      |      |
|                  |                   | $V_{CC}$ = 1.65 V to 1.95 V         |            | 1.5              | 4.5                  | 10.3 | 1.5               | 12.9 | ns   |
|                  |                   | $V_{CC}$ = 2.3 V to 2.7 V           |            | 1.0              | 2.9                  | 5.6  | 1.0               | 7.0  | ns   |
|                  |                   | $V_{CC} = 2.7 V$                    |            | 1.5              | 3.4                  | 5.6  | 1.5               | 7.0  | ns   |
|                  |                   | $V_{CC}$ = 3.0 V to 3.6 V           |            | 0.5              | 2.5                  | 4.7  | 0.5               | 5.9  | ns   |
|                  |                   | $V_{CC}$ = 4.5 V to 5.5 V           |            | 0.5              | 2.0                  | 3.8  | 0.5               | 4.8  | ns   |
| t <sub>dis</sub> | disable time      | nOE to nY; see Figure 8             | <u>[4]</u> |                  |                      |      |                   |      |      |
|                  |                   | $V_{CC}$ = 1.65 V to 1.95 V         |            | 1.0              | 3.5                  | 11.6 | 1.0               | 14.1 | ns   |
|                  |                   | $V_{CC}$ = 2.3 V to 2.7 V           |            | 0.5              | 1.9                  | 5.8  | 0.5               | 7.6  | ns   |
|                  |                   | $V_{CC} = 2.7 V$                    |            | 1.0              | 2.8                  | 4.5  | 1.0               | 5.8  | ns   |
|                  |                   | $V_{CC}$ = 3.0 V to 3.6 V           |            | 1.0              | 2.7                  | 4.4  | 1.0               | 5.7  | ns   |
|                  |                   | $V_{CC}$ = 4.5 V to 5.5 V           |            | 0.5              | 1.9                  | 3.4  | 0.5               | 4.6  | ns   |
| C <sub>PD</sub>  | power dissipation | per buffer; $V_I$ = GND to $V_{CC}$ | [5]        |                  |                      |      |                   |      |      |
|                  | capacitance       | output enabled                      |            | -                | 18                   | -    | -                 | -    | pF   |
|                  |                   | output disabled                     |            | -                | 5                    | -    | -                 | -    | pF   |

[1] Typical values are measured at nominal  $V_{CC}$  and at  $T_{amb} = 25 \text{ °C}$ .

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ 

- [3]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$
- [4] t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>
- [5]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$  $f_{i} = \text{input frequency in MHz;}$ 

 $I_i = Input frequency in MHZ;$ 

 $f_o$  = output frequency in MHz;  $C_L$  = output load capacitance in pF;

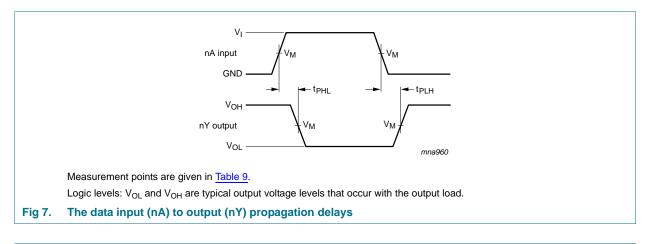
 $V_{CC}$  = supply voltage in V;

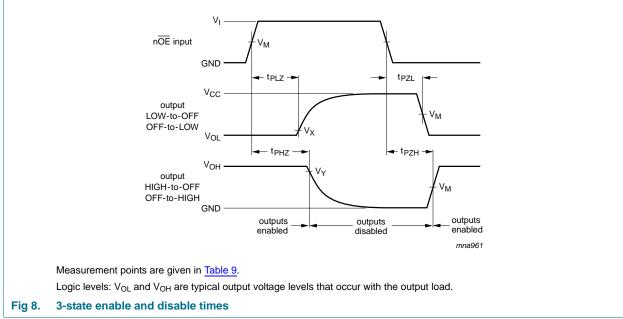
N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$  = sum of outputs.

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### 12. Waveforms





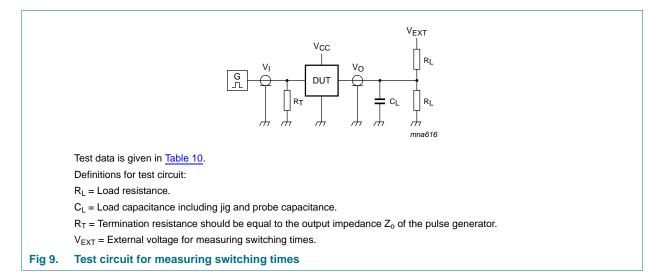
#### Table 9.Measurement points

| Supply voltage   | Input               | Output                     |                          |                          |
|------------------|---------------------|----------------------------|--------------------------|--------------------------|
| V <sub>cc</sub>  | V <sub>M</sub>      | V <sub>M</sub>             | V <sub>X</sub>           | V <sub>Y</sub>           |
| 1.65 V to 1.95 V | $0.5 	imes V_{CC}$  | $0.5 \times V_{\text{CC}}$ | V <sub>OL</sub> + 0.15 V | $V_{OH} - 0.15 \ V$      |
| 2.3 V to 2.7 V   | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$        | V <sub>OL</sub> + 0.15 V | V <sub>OH</sub> – 0.15 V |
| 2.7 V            | 1.5 V               | 1.5 V                      | V <sub>OL</sub> + 0.3 V  | $V_{OH} - 0.3 V$         |
| 3.0 V to 3.6 V   | 1.5 V               | 1.5 V                      | V <sub>OL</sub> + 0.3 V  | $V_{OH} - 0.3 \ V$       |
| 4.5 V to 5.5 V   | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$        | V <sub>OL</sub> + 0.3 V  | $V_{OH} - 0.3 \ V$       |

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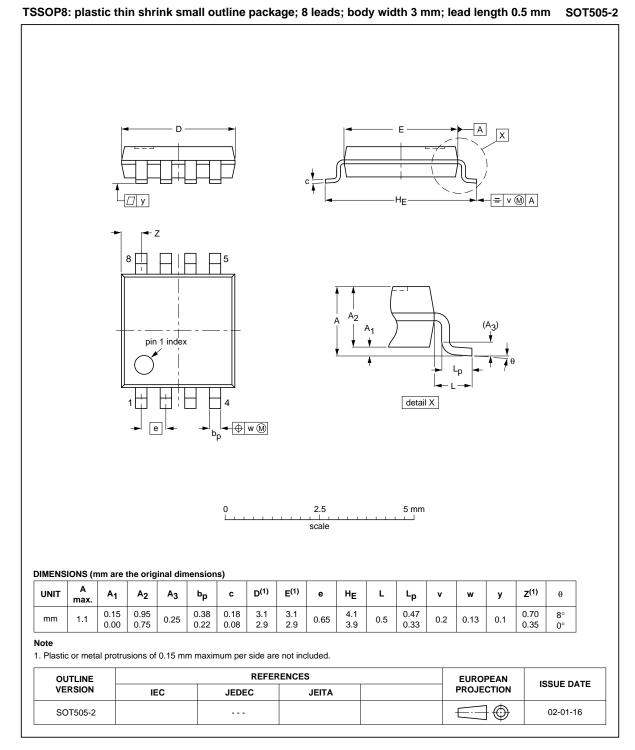


#### Table 10. Test data

| Supply voltage   | Input           | Load  |       | V <sub>EXT</sub>                    |                                     |                                     |
|------------------|-----------------|-------|-------|-------------------------------------|-------------------------------------|-------------------------------------|
|                  | VI              | CL    | RL    | t <sub>PLH</sub> , t <sub>PHL</sub> | t <sub>PZH</sub> , t <sub>PHZ</sub> | t <sub>PZL</sub> , t <sub>PLZ</sub> |
| 1.65 V to 1.95 V | V <sub>CC</sub> | 30 pF | 1 kΩ  | open                                | GND                                 | $2 \times V_{CC}$                   |
| 2.3 V to 2.7 V   | V <sub>CC</sub> | 30 pF | 500 Ω | open                                | GND                                 | $2 \times V_{CC}$                   |
| 2.7 V            | 2.7 V           | 50 pF | 500 Ω | open                                | GND                                 | 6 V                                 |
| 3.0 V to 3.6 V   | 2.7 V           | 50 pF | 500 Ω | open                                | GND                                 | 6 V                                 |
| 4.5 V to 5.5 V   | V <sub>CC</sub> | 50 pF | 500 Ω | open                                | GND                                 | $2 \times V_{CC}$                   |

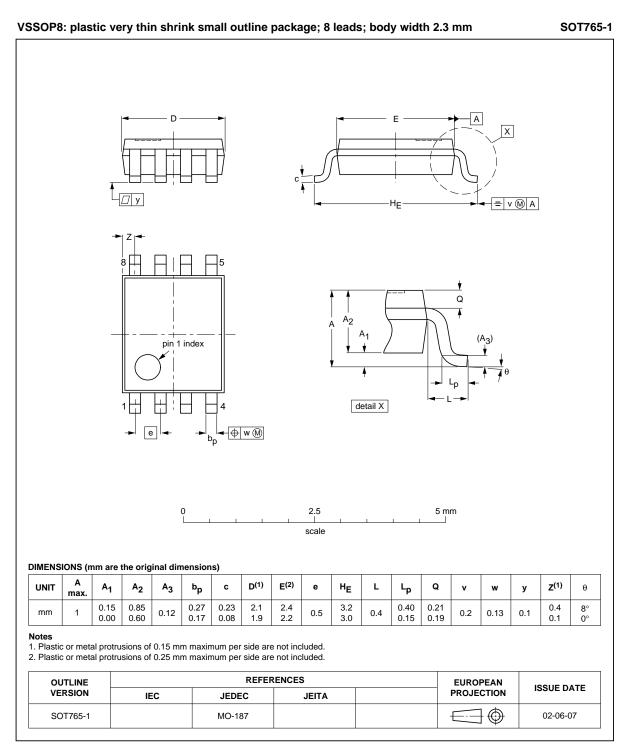
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### 13. Package outline



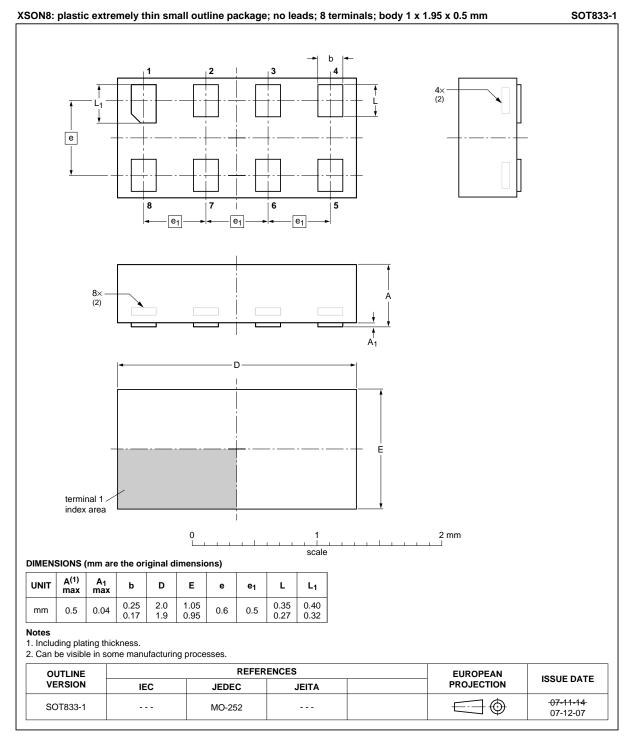
#### Fig 10. Package outline SOT505-2 (TSSOP8)

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#### Fig 11. Package outline SOT765-1 (VSSOP8)

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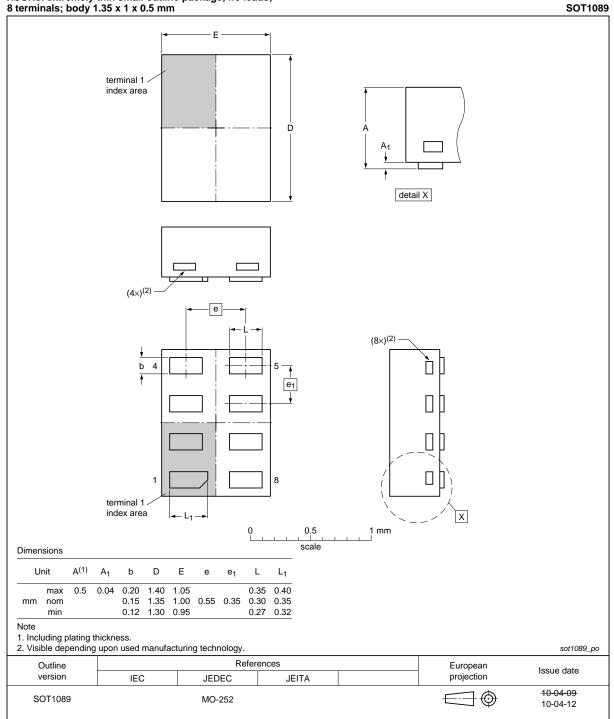
#### Fig 12. Package outline SOT833-1 (XSON8)

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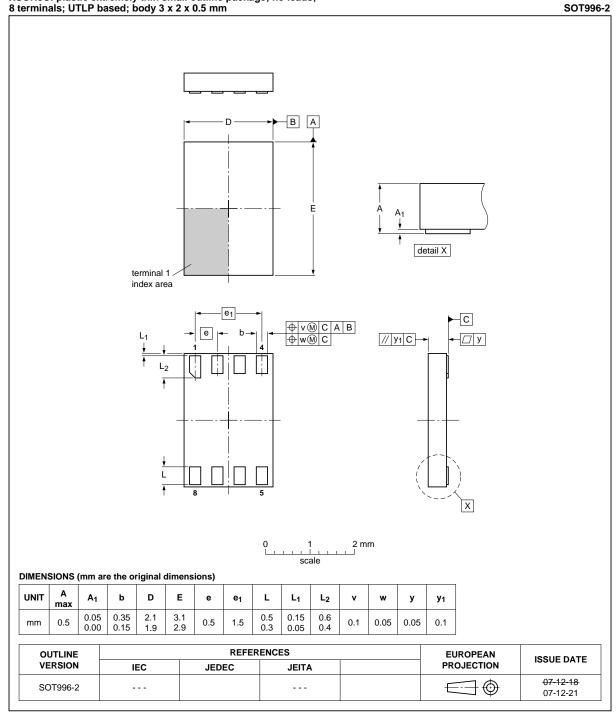
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## XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1 x 0.5 mm

Fig 13. Package outline SOT1089 (XSON8)

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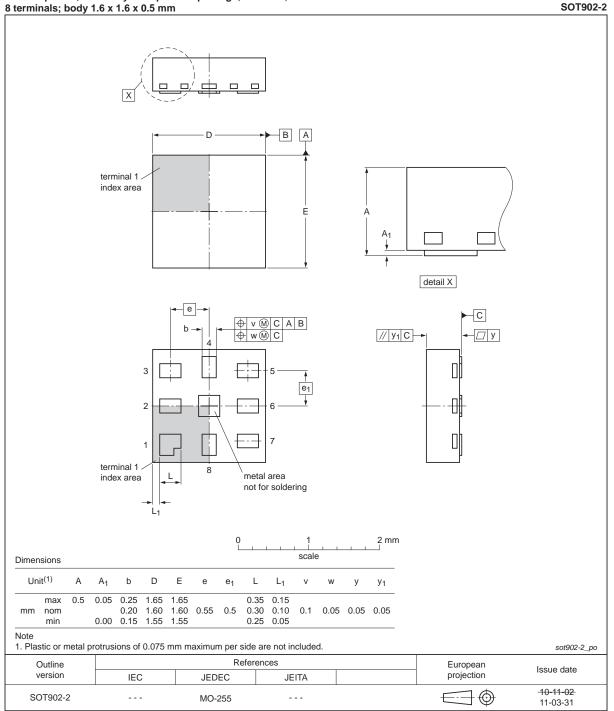


XSON8U: plastic extremely thin small outline package; no leads; 8 terminals; UTLP based; body 3 x 2 x 0.5 mm

#### Fig 14. Package outline SOT996-2 (XSON8U)

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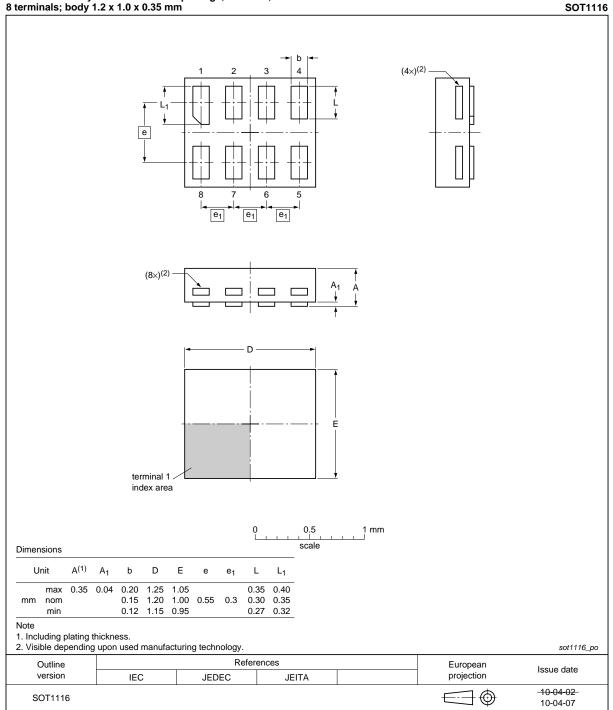


XQFN8: plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 x 1.6 x 0.5 mm

#### Fig 15. Package outline SOT902-2 (XQFN8)

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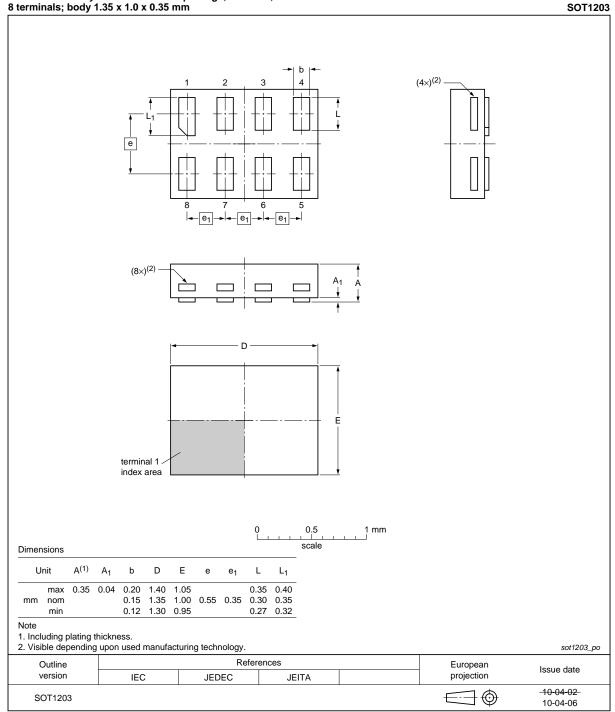


## XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.2 x 1.0 x 0.35 mm

Fig 16. Package outline SOT1116 (XSON8)

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## XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1.0 x 0.35 mm

Fig 17. Package outline SOT1203 (XSON8)

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### 14. Abbreviations

| Table 11. | Abbreviations                           |
|-----------|---|
| Acronym   | Description                             |
| CMOS      | Complementary Metal-Oxide Semiconductor |
| DUT       | Device Under Test                       |
| ESD       | ElectroStatic Discharge                 |
| HBM       | Human Body Model                        |
| MM        | Machine Model                           |
| TTL       | Transistor-Transistor Logic             |
|           |   |

### **15. Revision history**

| Table 12. Revision histo | ory                                      |                           |                  |                |
|--------------------------|--|---------------------------|------------------|----------------|
| Document ID              | Release date                             | Data sheet status         | Change notice    | Supersedes     |
| 74LVC2G240 v.7           | 20120622                                 | Product data sheet        | -                | 74LVC2G240 v.6 |
| Modifications:           | <ul> <li>For type nun</li> </ul>         | nber 74LVC2G240GM the SOT | code has changed | to SOT902-2.   |
| 74LVC2G240 v.6           | 20111128                                 | Product data sheet        | -                | 74LVC2G240 v.5 |
| Modifications:           | <ul> <li>Legal pages updated.</li> </ul> |                           |                  |                |
| 74LVC2G240 v.5           | 20100915                                 | Product data sheet        | -                | 74LVC2G240 v.4 |
| 74LVC2G240 v.4           | 20080229                                 | Product data sheet        | -                | 74LVC2G240 v.3 |
| 74LVC2G240 v.3           | 20071005                                 | Product data sheet        | -                | 74LVC2G240 v.2 |
| 74LVC2G240 v.2           | 20060728                                 | Product data sheet        | -                | 74LVC2G240 v.1 |
| 74LVC2G240 v.1           | 20030311                                 | Product specification     | -                | -              |

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| Document status[1][2]          | Product status <sup>[3]</sup> | Definition  |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet   | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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